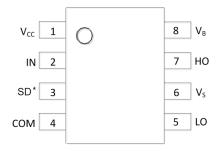


# Pin Diagrams

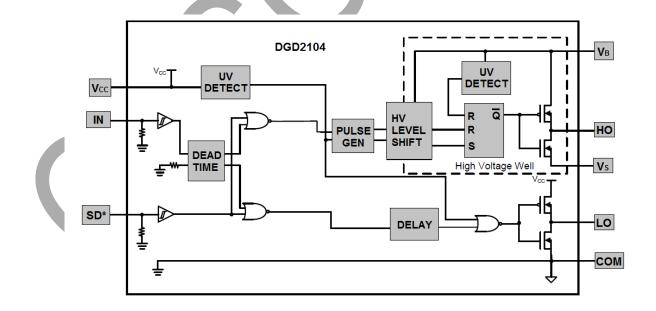


Top View: SO-8

## **Pin Descriptions**

Pin Number	Pin Name	Function
1	Vcc	Logic and Low Side Supply
2	IN	Logic Input for High-Side and Low-SideGate Driver Outputs (HO and LO), in Phase with HO
3	SD*	Logic input for Shutdown, Enabled Low
4	COM	Low-Side and Logic Return
5	LO	Low-Side Gate Drive Output
6	Vs	High-Side Floating Supply Return
7	НО	High-Side Gate Drive Output
8	V <sub>B</sub>	High-Side Floating Supply

# **Functional Block Diagram**





# **Absolute Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
High-Side Floating Supply Voltage	V <sub>B</sub>	-0.3 to +624	V
High-Side Floating Supply Offset Voltage	Vs	V <sub>B</sub> -24 to V <sub>B</sub> +0.3	V
High-Side Floating Output Voltage	V <sub>HO</sub>	V <sub>S</sub> -0.3 to V <sub>B</sub> +0.3	V
Offset Supply Voltage Transient	dV <sub>S</sub> / dt	50	V/ns
Low-Side Fixed Supply Voltage	V <sub>CC</sub>	-0.3 to +24	V
Low-Side Output Voltage	$V_{LO}$	-0.3 to V <sub>CC</sub> +0.3	V
Logic Input Voltage (IN and SD*)	V <sub>IN</sub>	-0.3 to V <sub>CC</sub> +0.3	V

# Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation Linear derating factor (Note 5)	$P_{D}$	0.625	W
Thermal Resistance, Junction to Ambient (Note 5)	R <sub>0JA</sub>	200	°C/W
Operating Temperature	TJ	+150	
Lead Temperature (Soldering, 10s)	TL	+300	°C
Storage Temperature Range	T <sub>STG</sub>	-55 to +150	

Note: 5. When mounted on a standard JEDEC 2-layer FR-4 board.

### **Recommended Operating Conditions**

Parameter		Symbol	Min	Max	Unit
High Side Floating Supply Absolute Voltage		$V_{B}$	Vs + 10	V <sub>S</sub> + 20	V
High Side Floating Supply Offset Voltage		Vs	(Note 6)	600	V
High Side Floating Output Voltage		VHO	Vs	$V_{B}$	V
Low Side Fixed Supply Voltage		Vcc	10	20	V
Low Side Output Voltage		$V_{LO}$	0	$V_{CC}$	<b>V</b>
Logic Input Voltage (IN and SD*)		V <sub>IN</sub>	0	5	V
Ambient Temperature		TA	-40	+125	°C

Note: 6. Logic operation for V<sub>S</sub> of -5V to +600V.





### DC Electrical Characteristics (V<sub>BIAS</sub> (V<sub>CC</sub>, V<sub>BS</sub>) = 15V, @T<sub>A</sub> = +25°C, unless otherwise specified.) (Note 7)

Parameter	Symbol	Min	Тур	Max	Unit	Condition
Logic "1" (IN) & Logic "0" (SD*) Input Voltage	$V_{IH}$	2.5	_	_	V	V <sub>CC</sub> = 10V to 20V
Logic "0" (IN) & Logic "1" (SD*) Input Voltage	VIL	_	_	0.8	V	V <sub>CC</sub> = 10V to 20V
High Level Output Voltage, V <sub>BIAS</sub> - V <sub>O</sub>	V <sub>OH</sub>	-	0.05	0.2	V	$I_O = 2mA$
Low Level Output Voltage, Vo	$V_{OL}$	_	0.02	0.1	V	$I_O = 2mA$
Offset Supply Leakage Current	$I_{LK}$	-	_	50	μΑ	$V_B = V_S = 600V$
Quiescent V <sub>BS</sub> Supply Current	I <sub>BSQ</sub>	-	60	100	μA	V <sub>IN</sub> = 0V or 5V
Quiescent V <sub>CC</sub> Supply Current	Iccq	_	350	500	μΑ	V <sub>IN</sub> = 0V or 5V
Logic "1" Input Bias Current	I <sub>IN+</sub>	-	3.0	10	μΑ	V <sub>IN</sub> = 5V, SD* = 0V
Logic "0" Input Bias Current	I <sub>IN-</sub>	_	_	5.0	μA	V <sub>IN</sub> = 0V, SD* = 5V
V <sub>CC</sub> Supply Undervoltage Positive Going Threshold	V <sub>CCUV+</sub>	8.0	8.9	9.8	V	-
V <sub>CC</sub> Supply Undervoltage Negative Going Threshold	V <sub>CCUV</sub> -	7.4	8.2	9.0	V	-
Output High Short Circuit Pulsed Current	I <sub>O+</sub>	130	290	_	mA	V <sub>O</sub> = 0V, PW ≤ 10μs
Output Low Short Circuit Pulsed Current	I <sub>O-</sub>	270	600		mA	V <sub>O</sub> = 15V, PW ≤ 10μs

Note: 7. The V<sub>IN</sub> and I<sub>IN</sub> parameters are applicable to the two logic pins: IN and SD\*. The V<sub>O</sub> and I<sub>O</sub> parameters are applicable to the respective output pins: HO and LO.

# AC Electrical Characteristics ( $V_{BIAS}$ ( $V_{CC}$ , $V_{BS}$ ) = 15V, $C_L$ = 1000pF, @ $T_A$ = +25°C, unless otherwise specified.)

Parameter	Symbol	Min	Тур	Max	Unit	Condition
Turn-On Propagation Delay	t <sub>ON</sub>	-	680	820	ns	$V_S = 0V$
Turn-Off Propagation Delay	toff	-	150	220	ns	V <sub>S</sub> = 600V
Shutdown Propagation Delay	t <sub>SD</sub>	-	160	220	ns	_
Delay Matching, HO and LO Turn-On/Turn-Off	t <sub>DM</sub>		_	60	ns	-
Turn-On Rise Time	t <sub>R</sub>	-	70	170	ns	V <sub>S</sub> = 0V
Turn-Off Fall Time	t <sub>F</sub>	1	35	90	ns	V <sub>S</sub> = 0V
Deadtime: tpt i 0-но & tpt но-го	tпт	400	520	650	ns	_





#### **Timing Waveforms**

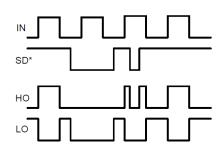


Figure 1. Input / Output Timing Diagram

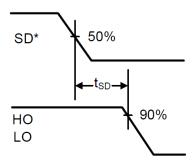
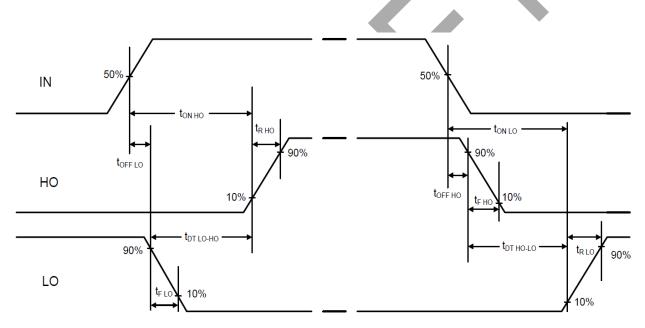


Figure 2. Shutdown Waveform Definition



Deadtime  $t_{DT LO-HO} = t_{ON HO} - t_{OFF LO}$  $t_{DT HO-LO} = t_{ON LO} - t_{OFF HO}$ 

Deadtime matching  $t_{\text{MDT}} = t_{\text{DT LO-HO}} - t_{\text{DT HO-LO}}$ 

 $\begin{array}{c} \text{Delay matching} \\ t_{\text{DM OFF}} = t_{\text{OFF LO}} - t_{\text{OFF HO}} \\ t_{\text{DM ON}} = t_{\text{ON LO}} - t_{\text{ON HO}} \end{array}$ 

Figure 3. Switching Time Waveform Definitions



# Typical Performance Characteristics (@TA = +25°C, unless otherwise specified.)

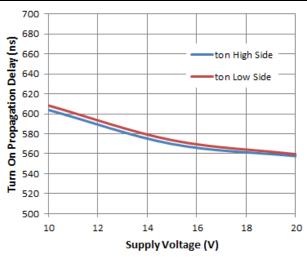


Figure 4. Turn-on Propagation Delay vs. Supply Voltage

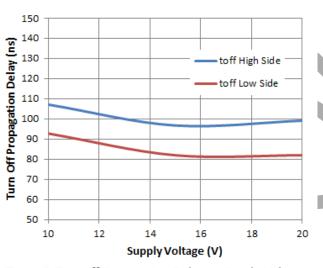


Figure 6. Turn-off Propagation Delay vs. Supply Voltage

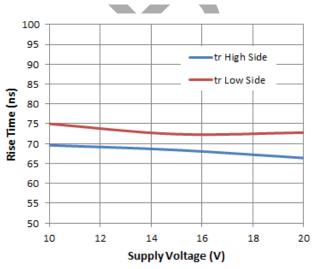


Figure 8. Rise Time vs. Supply Voltage

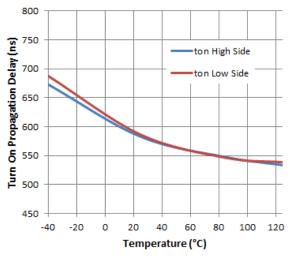


Figure 5. Turn-on Propagation Delay vs. Temperature

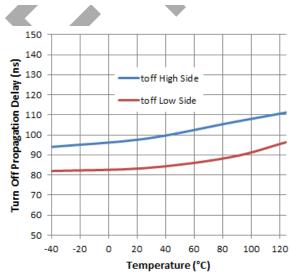


Figure 7. Turn-off Propagation Delay vs. Temperature

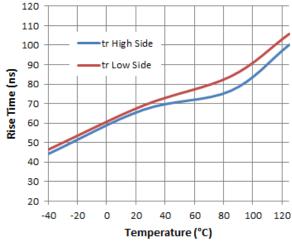


Figure 9. Rise Time vs. Temperature



### **Typical Performance Characteristics (Cont.)**

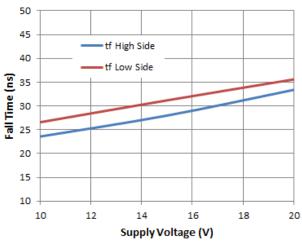


Figure 10. Fall Time vs. Supply Voltage

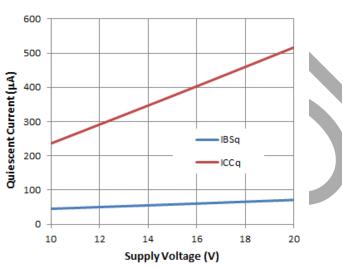


Figure 12. Quiescent Current vs. Supply Voltage

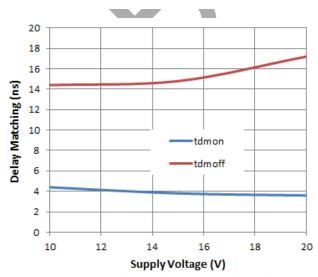


Figure 14. Delay Matching vs. Supply Voltage

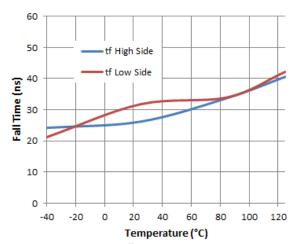


Figure 11. Fall Time vs. Temperature

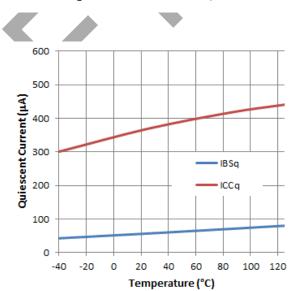


Figure 13. Quiescent Current vs. Temperature

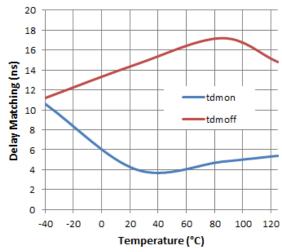


Figure 15. Delay Matching vs. Temperature



# **Typical Performance Characteristics (Cont.)**

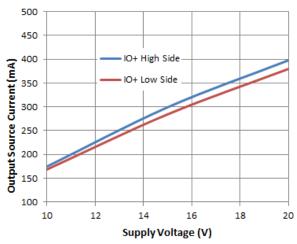


Figure 16. Output Source Current vs. Supply Voltage

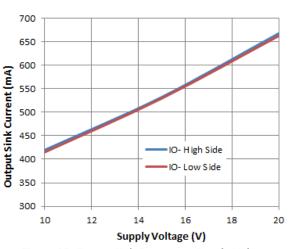


Figure 18. Output Sink Current vs. Supply Voltage

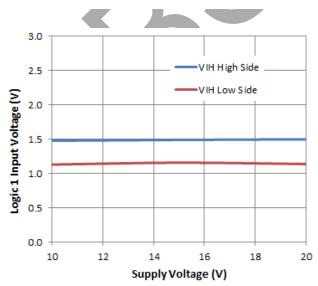


Figure 20. Logic 1 Input Voltage vs. Supply Voltage

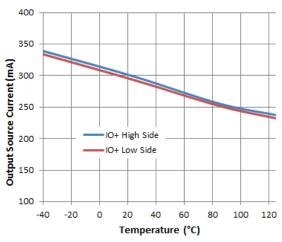


Figure 17. Output Source Current vs. Temperature

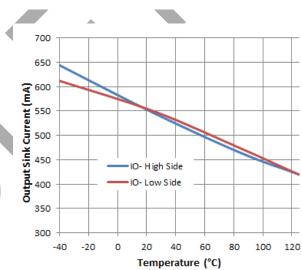


Figure 19. Output Sink Current vs. Temperature

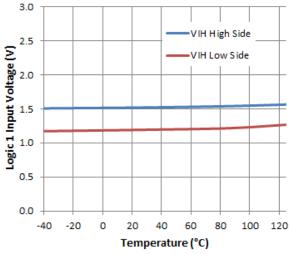


Figure 21. Logic 1 Input Voltage vs. Temperature



### **Typical Performance Characteristics (Cont.)**

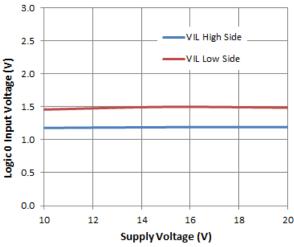


Figure 22. Logic O Input Voltage vs. Supply Voltage

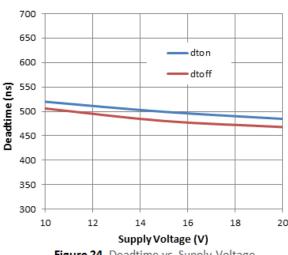


Figure 24. Deadtime vs. Supply Voltage

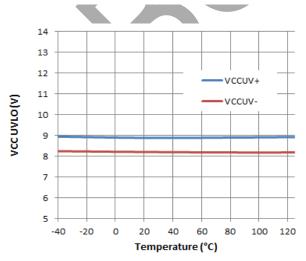


Figure 26. VCC UVLO vs. Temperature

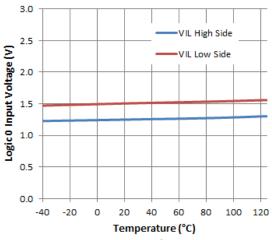


Figure 23. Logic 0 Input Voltage vs. Temperature

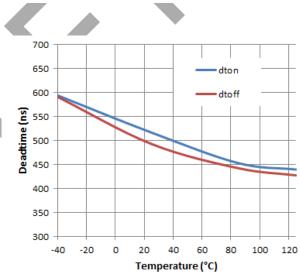


Figure 25. Deadtime vs. Temperature

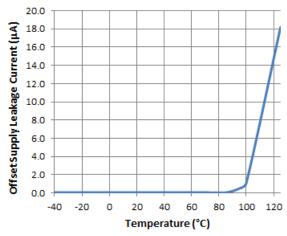


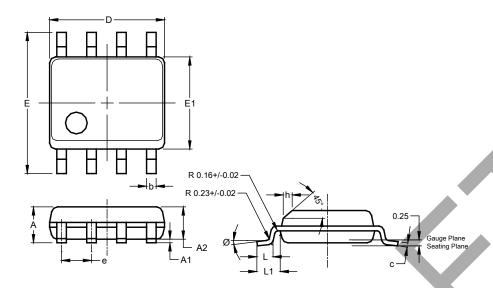
Figure 27. Offset Supply Leakage Current vs. Temperature



#### **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### SO-8 (Type TH)

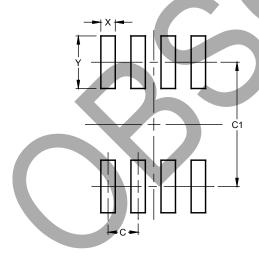


SO-8 (Type TH)						
Dim	Min	Max	Тур			
Α	1.35	1.75				
A1	0.10	0.25	-			
A2			1.45			
b	0.35	0.51				
С	0.190	0.248	-			
D	4.80	5.00	4.90			
Е	5.80	6.20	6.00			
E1	3.80	4.00	3.90			
е			1.27			
h	0.25	0.50				
٦	0.41	1.27				
L1			1.04			
Ø	0°	8°				
All Dimensions in mm						

### **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

SO-8 (Type TH)



Dimensions	Value (in mm)
C	1.27
C1	5.20
Х	0.60
Υ	2.20

Note: For high voltage applications, the appropriate industry sector guidelines should be considered with regards to creepage and clearance distances between device Terminals and PCB tracking.



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